

BGY587 550 MHz, 22 dB gain push-pull amplifier Rev. 5 – 20 September 2011

**Product data sheet** 

# 1. Product profile

## 1.1 General description

Hybrid amplifier module in a SOT115J package, operating at a supply voltage of 24 V. The BGY587 is intended for use as a final amplifier.

#### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

### **1.2 Features and benefits**

- Excellent linearity
- Extremely low noise
- Silicon nitride passivation
- Rugged construction
- TiPtAu metallized crystals ensure excellent reliability

### **1.3 Applications**

CATV systems operating in the 40 MHz to 550 MHz frequency range

### 1.4 Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	f = 50 MHz	21.5	-	22.5	dB
		f = 550 MHz	22	-	-	dB
I <sub>tot</sub>	total current consumption (DC)	$V_B = 24 V$	<u>[1]</u> -	220	240	mA

[1] The module normally operates at  $V_B = 24$  V, but is able to withstand supply transients of up to 30 V.



# 2. Pinning information

Pin	Description	
	Description	Simplified outline Symbol
1	input	
2	common	1 3 5 7 9 5
3	common	
5	+V <sub>B</sub>	
7	common	2 3 7 0 sym09
8	common	
9	output	

# 3. Ordering information

Table 3. Ordering information					
Type number	Package				
	Name	Description	Version		
BGY587	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads	SOT115J		

# 4. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Vi	RF input voltage		-	65	dBmV
T <sub>stg</sub>	storage temperature		-40	+100	°C
T <sub>mb</sub>	mounting base temperature		-20	+100	°C

## 5. Characteristics

#### Table 5. Characteristics

Bandwidth 40 MHz to 550 MHz;  $V_B = 24$  V;  $T_{mb} = 30$  °C;  $Z_S = Z_L = 75 \Omega$  unless otherwise specified.

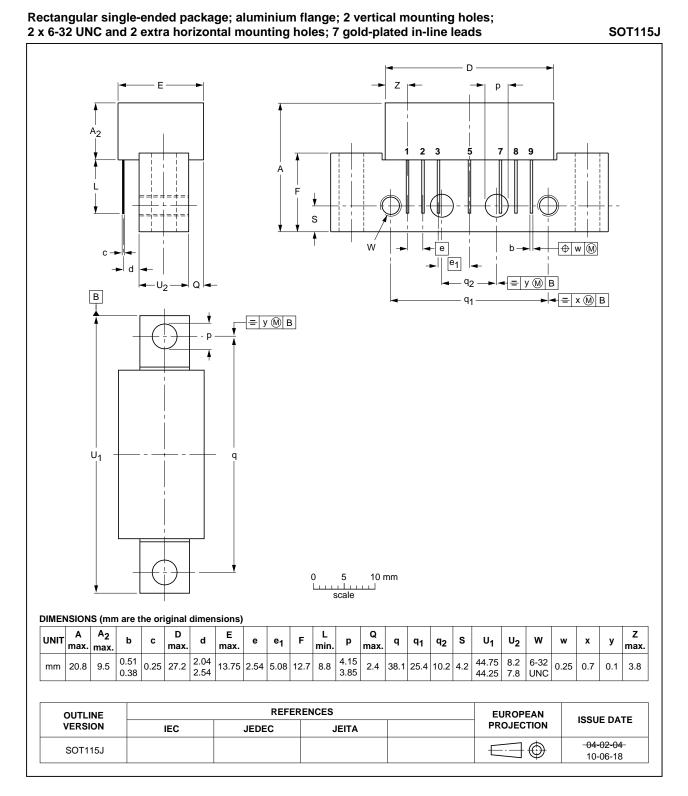
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
G <sub>p</sub>	power gain	f = 50 MHz	21.5	-	22.5	dB
		f = 550 MHz	22	-	-	dB
SL	slope cable equivalent	f = 40 MHz to 550 MHz	0.2	-	1.5	dB
FL	flatness of frequency response	f = 40 MHz to 550 MHz	-	-	±0.2	dB
s <sub>11</sub>	input return	f = 40 MHz to 80 MHz	20	-	-	dB
	losses	f = 80 MHz to 160 MHz	19	-	-	dB
		f = 160 MHz to 550 MHz	18	-	-	dB
S <sub>22</sub>	output return losses	f = 40 MHz to 80 MHz	20	-	-	dB
		f = 80 MHz to 160 MHz	19	-	-	dB
		f = 160 MHz to 550 MHz	18	-	-	dB
φs21	phase response	f = 50 MHz	+135	-	+225	deg
СТВ	composite triple beat	77 channels flat; $V_o = 44 \text{ dBmV}$ ; measured at 547.25 MHz	-	-	-57	dB
X <sub>mod</sub>	cross modulation	77 channels flat; $V_o = 44 \text{ dBmV}$ ; measured at 55.25 MHz	-	-	-58	dB
CSO	composite second order distortion	77 channels flat; $V_0 = 44 \text{ dBmV}$ ; measured at 548.25 MHz	-	-	-54	dB
d <sub>2</sub>	second order distortion		<u>[1]</u> _	-	-66	dB
Vo	output voltage	$d_{im} = -60 \text{ dB}$	<mark>[2]</mark> 61	-	-	dBmV
NF	noise figure	f = 550 MHz	-	-	7	dB
I <sub>tot</sub>	total current consumption (DC)		<u>[3]</u> _	220	240	mA

[1]  $f_p = 55.25$  MHz;  $V_p = 44$  dBmV;  $f_q = 493.25$  MHz;  $V_q = 44$  dBmV; measured at  $f_p + f_q = 548.5$  MHz.

[2] Measured according to DIN45004B;

 $f_p = 540.25 \text{ MHz}; V_p = V_o; f_q = 547.25 \text{ MHz}; V_q = V_o - 6 \text{ dB}; f_r = 549.25 \text{ MHz}; V_r = V_o - 6 \text{ dB};$  measured at  $f_p + f_q - f_r = 538.25 \text{ MHz}.$ [3] The module normally operates at  $V_B = 24 \text{ V}$ , but is able to withstand supply transients up to 30 V.

# 6. Package outline



#### Fig 1. Package outline SOT115J

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# 7. Revision history

Table 6. Revision h	nistory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BGY587 v.5	20110920	Product data sheet	-	BGY587 v.4
Modifications:		of this data sheet has been of NXP Semiconductors.	redesigned to comply v	vith the new identity
	<ul> <li>Legal texts</li> </ul>	have been adapted to the ne	ew company name whe	ere appropriate.
	<ul> <li>Package or</li> </ul>	utline drawings have been up	odated to the latest ver	sion.
BGY587 v.4 (9397 750 14764)	20050411	Product data sheet	-	BGY587 v.3
BGY587 v.3 (9397 750 08966)	20011127	Product specification	-	BGY586 v.2
BGY586 v.2	19940207	n.a.	n.a.	-

# 8. Legal information

#### 8.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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# **BGY587**

#### 550 MHz, 22 dB gain push-pull amplifier

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